503277148 04/23/2015

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3323766

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEONGPIL CHO	03/30/2015
YONGIL KIM	03/30/2015

RECEIVING PARTY DATA

Name:	LG DISPLAY CO., LTD.
Street Address:	128, YEOUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14629544

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	065543-5422	
NAME OF SUBMITTER:	ROBERT J. GOODELL	
SIGNATURE:	/Robert J. Goodell/	
DATE SIGNED:	04/23/2015	

Total Attachments: 1

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PATENT 503277148 REEL: 035481 FRAME: 0795

ATTORNEY DOCKET NO.: 065543-5422 SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

THIN FILM TRANSISTOR SUBSTRATE AND DISPLAY USING THE SAME for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on <u>February 24, 2015</u>, (Application No. <u>14/629,544</u>); and

WHEREAS, LG Display Co., Ltd., a corporation of Republic of Korea, whose post office address is 128, Yeoui-daero, Yeongdeungpo-gu, Seoul, 150-721, Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

	and request the attorneys I/WE have empowere	
	, to insert here in parenthesis (Application No. cation number of said application when known.	, filed
) he mag date and uppn	soutor ranges or said appreciator russ moves.	•
IN TESTIMONY WHEREOF, I/	WE have hereunto set our hand(s).	
Full Name of Sole or First Assignor	Assignor's Signature	Date
Seengpil CHO	Assignor's Signature	Mer 30, 2015
Address	.ddress	
908-1403, Hugokmaeul 9-danji Apt., Ilsan 3-	Republic of Korea	
Republic of Korea		
Full Name of Second Assignor	Assignor's Signature	Date
Yongil KIM	Yangil RM	1. May 20. 20/1
Address		Citizenship
342, Cheongggeum-ri, Songak-myeon, Dang	Republic of Korea	
Republic of Korea		
Names of additional inventors attached \[\]Y	es 🖾 No	
tusted of succession arresters underson []	AN KER YAN	
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PATENT REEL: 035481 FRAME: 0796